Vishay General Semiconductor

High Current Density Surface Mount Ultrafast Rectifiers



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Cathode O Anode

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	1.0 A			
V _{RRM} 100 V, 150 V, 200 V				
t _{rr}	15 ns			
V _F at I _F	0.92 V			
T _J max.	150 °C			
Package	SMP (DO-220AA)			
Circuit configuration	Single			

FEATURES

- Very low profile typical height of 1.0 mm
- · Ideal for automated placement
- Glass passivated pellet chip junction
- · Ultrafast recovery times for high efficiency
- · Low forward voltage, low power losses
- · Low thermal resistance
- Meets MSL level 1 per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in secondary rectification and freewheeling for ultrafast switching speeds of AC/DC and DC/DC converters for both consumer and automotive applications.

MECHANICAL DATA

Case: SMP (DO-220AA)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and automotive grade

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	ES1PB	ES1PC	ES1PD	UNIT	
Device marking code		EB	EC	ED		
Maximum repetitive peak reverse voltage	V _{RRM}	100	150	200	V	
Maximum average forward rectified current (fig. 1)	I _{F(AV)}	1.0			А	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	30			A	
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150			°C	



ES1PB, ES1PC, ES1PD



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ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	VALUE	UNIT	
Maximum instantaneous forward voltage	I _F = 0.6 A	T _J = 25 °C	V _F ⁽¹⁾	0.865	v	
	$I_F = 1 A$			0.920		
Maximum reverse current at	Maximum reverse current at $T_J = 25 \ ^{\circ}C$	- I _B ⁽²⁾	5.0	μA		
rated V _R		T _J = 125 °C	^I R ⁽⁻⁾	500	μΑ	
Maximum reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1 \text{ A}, I_{rr} = 0.25 \text{ A}$		t _{rr}	15	ns	
Typical reverse recovery time	$I_{F} = 1.0 \text{ A}, V_{R} = 30 \text{ V}, \\ dI/dt = 50 \text{ A}/\mu \text{s}, I_{rr} = 10 \% I_{RM}$	T _J = 25 °C	t _{rr}	25	ns	
		$T_J = 100 \ ^\circ C$		30		
Typical stored charge	I _F = 1.0 A, V _B = 30 V,	T _J = 25 °C	Q _{rr}	8	nC	
	dl/dt = 50 A/ μ s, I _{rr} = 10 % I _{RM}	T _J = 100 °C		10		
Typical junction capacitance	4.0 V, 1 MHz		CJ	10	pF	

Notes

⁽¹⁾ Pulse test: 300 μ s pulse width, 1 % duty cycle ⁽²⁾ Pulse test: Pulse width \leq 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	ES1PB	ES1PC	ES1PD	UNIT	
	R _{0JA} ⁽¹⁾	105				
Typical thermal resistance	$R_{ ext{ hetaJL}}$ (1)		15	°C/W		
	R _{0JC} ⁽¹⁾		20		1	

Note

⁽¹⁾ Thermal resistance from junction to ambient and junction to lead mounted on PCB with 5.0 mm x 5.0 mm copper pad areas. R_{θJL} is measured at the terminal of cathode band. $R_{\theta JC}$ is measured at the top center of the body

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
ES1PB-M3/84A	0.024	84A	3000	7" diameter plastic tape and reel		
ES1PB-M3/85A	0.024	85A	10 000	13" diameter plastic tape and reel		
ES1PBHM3/84A (1)	0.024	84A	3000	7" diameter plastic tape and reel		
ES1PBHM3/85A (1)	0.024	85A	10 000	13" diameter plastic tape and reel		

Note

⁽¹⁾ Automotive grade





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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

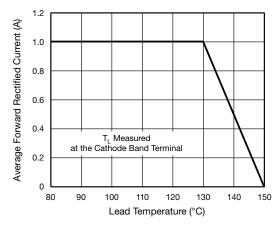


Fig. 1 - Maximum Forward Current Derating Curve

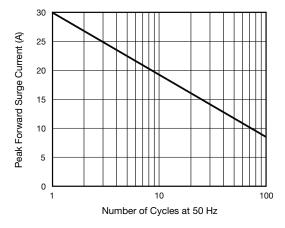


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

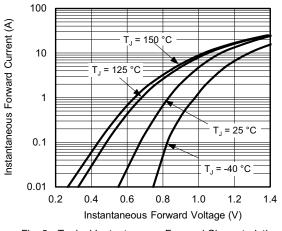


Fig. 3 - Typical Instantaneous Forward Characteristics

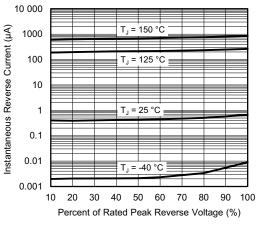


Fig. 4 - Typical Reverse Leakage Characteristics

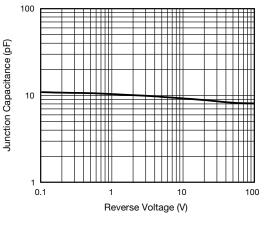


Fig. 5 - Typical Junction Capacitance

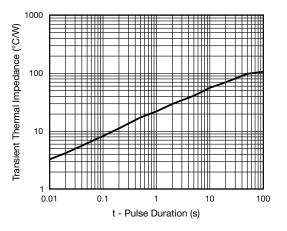


Fig. 6 - Typical Transient Thermal Impedance

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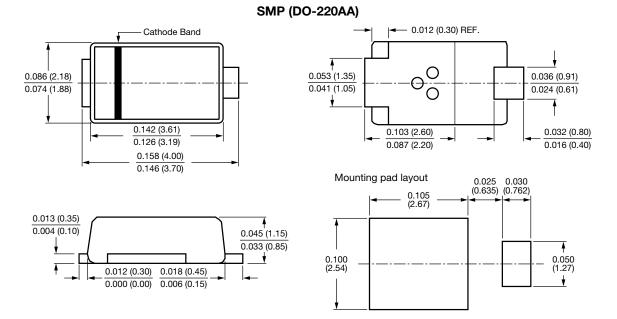
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

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